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## **ATX Power Connector**

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### **1. SCOPE**

#### **1.1. CONTENTS**

This specification covers the performance, tests and quality requirements for the ATX Power Connector.

#### **1.2. QUALIFICATION**

When tests are performed on the subject product line, the procedures specified in Tyco 109 series specifications shall be used. All inspections shall be performed using the applicable inspection plan and product drawing.

### **2. APPLICABLE DOCUMENT**

The following Tyco documents form a part of this specification to the extent specified herein. Unless otherwise specified, the latest edition of the document applies. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence. In the event of conflict between the requirements of this specification and the referenced documents, this specification shall take precedence.

#### **2.1. TYCO SPECIFICATIONS**

- A. 109-1: General Requirements for Test Specifications
- B. 109-197 : Tyco Specification vs EIA Test Methods
- C. 501-57426 : Test Report

### **3. REQUIREMENTS**

#### **3.1. DESIGN AND CONSTRUCTION**

Product shall be of the design, construction and physical dimensions specified on the applicable product drawing.

#### **3.2. MATERIALS**

- A. Housing : Thermoplastic UL94V-0/UL94V-2
- B. Contact : Copper Alloy, Tin Plating over Nickel underplating overall.

#### **3.3. RATINGS**

- A. Voltage : 250 VAC rms.
- B. Current : 9A Max.
- C. Temperature : -25°C to +85°C

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**3.4. PERFORMANCE REQUIREMENT AND TEST DESCRIPTION**

The product shall be designed to meet the electrical, mechanical and environmental performance requirements specified in Figure 1. All tests shall be performed at ambient environmental conditions per AMP Specification 109-1TEST REQUIREMENTS AND PROCEDURES SUMMARY.

**3.5. TEST REQUIREMENTS AND PROCEDURES SUMMARY**

TEST ITEM		REQUIREMENT	PROCEDURE
1	Examination of Product	Meets requirements of product drawing. No physical damage.	Visual inspection.
<b>ELECTRICAL REQUIREMENT</b>			
2	Contact Resistance	20 m Ohm Max. (Initial) 50 m Ohm Max. (Final)	Subject mated contacts assembled in housing to 20mV Max open circuit at 10mA Max. EIA-364-6B.
3	Dielectric withstanding Voltage	No creeping discharge or flashover shall occur. Current leakage: 0.5 mA MAX	1500VAC for 1minute Test between adjacent circuits of unmated connector. EIA-364-20B
4	Insulation Resistance	1000 M Ohm Min.	Impressed voltage 500 VDC. Test between adjacent circuits of unmated connector. EIA-364-21C.
<b>MECHANICAL REQUIREMENT</b>			
5	Connector Mating Force	4.41N(0.45Kgf)/Pin Max.	Operation Speed : 25±3mm/min. Measure the force required to mate connector. EIA-364-13B
6	Connector Unmating Force	1.47N(0.15Kgf) /Pin Min..	Operation Speed : 25±3 mm/min. Measure the force required to unmate connector. EIA-364-13B
7	Durability	See Note	Operation Speed : 25.4mm/minute. Durability Cycles : 50 Cycles EIA-364-9C
8	Vibration	No electrical discontinuity greater than 1 μ sec shall occur. See Note.	Subject mated connectors to 10-55-10 Hz traversed in 1minutes at 1.52mm amplitude 2 Hours each of 3 mutually perpendicular planes. 100mA Max. Applied. EIA-364-28D
9	Mechanical Shock	No electrical discontinuity greater than 1 μ sec shall occur. See Note.	Accelerate Velocity : 490m/s <sup>2</sup> (50G) Waveform : Half-sine shock plus Duration : 11msec No. of Drops : 3 drops each to normal and reversed directions of X,Y and Z axes, totally 18 drops, passing DC 1mA current during the test. EIA-364-27B

Figure 1 ( Cont. )

MECHANICAL REQUIREMENT		
TEST ITEM	REQUIREMENT	PROCEDURE
10	Contact Retention Force	2.5 Kgf/per pin Min. Measure the contact retention force with Tensile strength tester.
11	Solder ability	Wet solder coverage : 95% Min. Solder Temperature : 235+/-5°C Duration : 5+/-0.5 sec, J-STD-002B
ENVIRONMENTAL REQUIREMENTS		
12	Resistance to Wave Soldering Heat	No physical damage shall occur. Solder Temp. : 265±5°C, 10±0.5sec. Tyco spec. 109-202, Condition B
13	Thermal Shock	See Note Mated Connector -55+/-3°C (30 minutes), +85+/-2°C (30 minutes) Perform this a cycle, repeat 5 cycles EIA-364-32C
14	Humidity-Temperature Cycle	See Note Mated Connector 25~65°C, 90~95% RH, 10 Cycles EIA-364-31B.
15	Temperature Life (Heat Aging)	See Note Mated Connector 85°C, 250 hours, EIA-364-17B.
16	Salt Spray	No detrimental corrosion allowed in contact area and base metal exposed. Subject mated connectors to 35+/-2°C and 5+/-1% salt condition for 48hours. After test, rinse the sample with water and recondition the room temperature for 1 hour. EIA-364-26B.

Figure 1 ( End )

NOTE : Shall meet visual requirements, show no physical damage, and meet requirement of additional tests as specified in the test sequence in Figures 2

**3.6. PRODUCT QUALIFICATION AND REQUALIFICATION TEST**

Test or Examination	Test Group								
	A	B	C	D	E	F	G	H	I
	Test Sequence (a)								
Examination of Product	1, 7	1, 9	1, 6	1, 5	1, 5	1, 5	1, 5	1, 3	1, 3
Contact Resistance		2, 8	2, 5	2, 4	2, 4	2, 4	2, 4		
Dielectric withstanding Voltage	3, 6								
Insulation Resistance	2, 5								
Mating Force		3, 7							
Unmating Force		4, 6							
Durability		5							
Vibration			3						
Mechanical Shock			4						
Contact Retention Force								4	
Solderability									2
Resistance to Soldering Heat								2	
Thermal Shock				3					
Humidity Temperature Cycling	4				3				
Temperature Life						3			
Salt Spray							3		

**Figure 2**

**NOTE : (a) Numbers indicate sequence in which tests are performed.**

**(b) Discontinuities shall not take place in this test group, during tests.**